

SPECIFICATIONS

Housing: Hi-Temp. Plastic(UL94 V-0)

Terminal: Phosphor Bronze, Gold Plating On Contact Area,
Tin Plating On Solder Tail.

Current Rating: 0.5A Max.

Dielectric Withstanding Voltage: 500V AC R.M.S. For 1 Minute

Insulation Resistance: 1000 Megohms Min. At DC 500V

Contact Resistance: 50 Milliohms Max.

Durability: 5000 Cycles

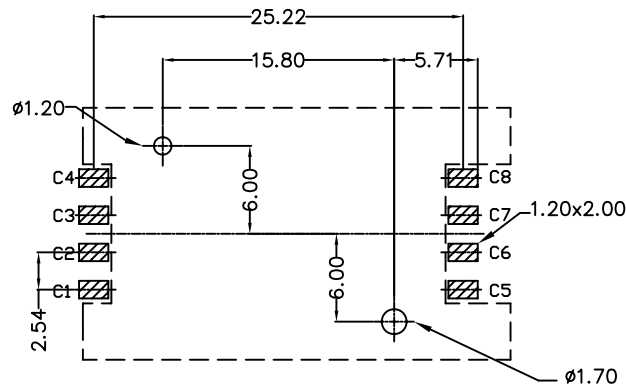
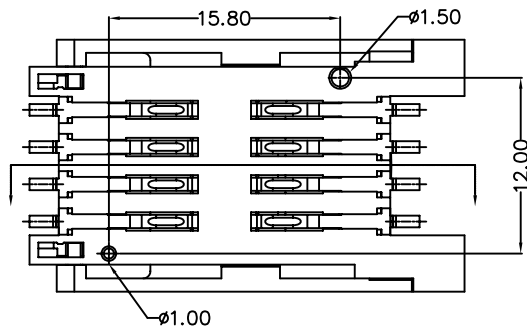
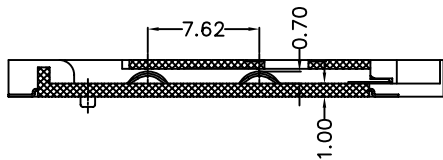
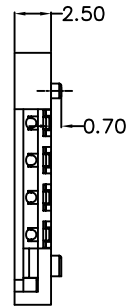
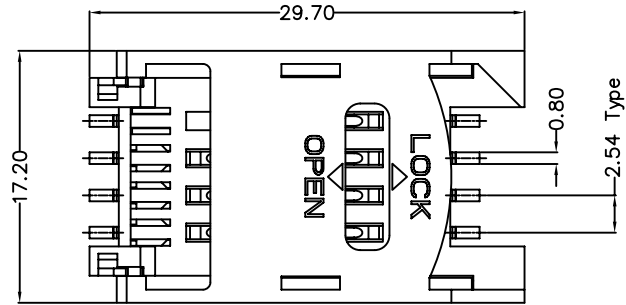
Manual Soldering: 360°C, 3 Sec Max.

Vapor Phase : 215°C, 30 Sec Max.

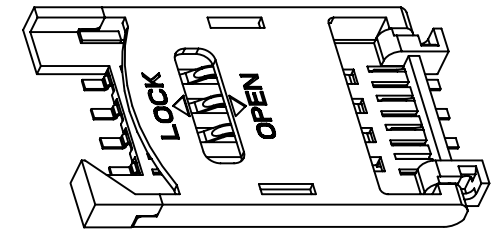
IR Reflow: 260°C, 15 Sec Max.

Operation Temperature: -25°C To +85°C

RoHS Compliant



(.XX±0.05)
REFERENCE PCB LAYOUT



4UCON 元化興業股份有限公司
4UCON TECHNOLOGY INC.

DRAWING No.

09899

APPROVED BY

MEI

CHECKED BY

LHC

DRAWING BY

XSH

UNLESS OTHERWISE SPECIFIED

TOLERANCES ARE

.X ±0.38

.XX ±0.25

ANG: ±1°

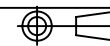
SCALE

NONE

REV.

AO

UNIT



NO. REV.

△ AO

New Release

REVISIONS

CHK

XSH 04/24/2006

DATE